LAYING TECHNIQUES FOR STATIC CONTROL TILES



Before laying the flooring, examine it to detect any problems of a visual nature. If there is an aspect defect, inform Gerflor and do not start laying without its agreement.

In accordance with the local standards

ASTATIC (ASF) ANTISTATIC FLOORING < 2kW Standard laying. These floorings do not need any special laying method. (No copper strip)

DISSIPATIVE (DIF) AND CONDUCTIVE (ECF) FLOORING

Lay with conductive* pre-coating, conductive adhesive, + copper strip: code 0586 (length: 200 lm) Store adhesive and rolls (unrolled and laid flat) 24 H in the area to be floored before laying.

* Only in the case of an application with a conductive adhesive in aqueous phase

• 1 - CHOICE OF JOINT TREATMENT

This product must be installed with a coving system and welded at least 24h after gluing.

• 2 - LAYING (METHOD B)

Preliminary arrangements

As this flooring has special electrical properties, it should be laid using the following method.

2.1 - Application of the conductive pre-coating

• Thoroughly mix the product before every application, then with a foam roller uniformly apply a thin coat of conductive primer at about 100 to 150 gr/m2.

• Let it dry in accordance with the adhesive manufacturer's recommendations.

NB: If a dual component reactive adhesive is used, DO NOT APPLY A CONDUCTIVE PRIMER (in aqueous phase)

2.2 - Installing the strip

• Put 2 lm of the strip every 40m2.

- Leave an end (of about 15 cm) for the electrician to connect to earth.
- The strip is laid on the pre-coating then embedded in the adhesive.
- We advise ring earthing the area 10 cm from the walls
- The copper strip remains visible by telegraphing after laying. This enables it to be located.



2.3 - Applying adhesive

· Spread the adhesive with a spatula recommended by the adhesive manufacturer) on the surface compatible with its setting time.

- Take care not to cut or damage the strip when applying adhesive.
- · Adhesive can be applied to the strip.
- Coverage: depends on the nature and composition of the adhesive (about 250 to 300 gr/m2).

SPECIFICATION FOR BONDING CONDUCTIVE FLOORING

• The electrical resistance of the dry film of adhesive and the floor covering is between 5 x 10⁴ and 10⁷ Ohms for conductive floorings and from 10⁷ to 10⁹ for dissipative floorings according to the NF EN 13 415-NF EN 1081 standard (tripod method) or the NF EN 61-340-4-1 standard (electrode method) or the ASTM F 150 NF PA 99 (superficial resistivity ESD S.1 and transversal resistivity ESD S 7) or CEI 1340-4-1 (CNET Electrod)

• The adhesive manufacturer must ensure the stability of the electrical resistance of the dry film which is given for a service life of over 10 years;

• Users' specifications require a value between 5×10^4 and 10^6 Ohms on the sample flooring presented, because of the loss due to bonded laying and to the distance of the earth.

2.4 - Laying tiles

• Put the first tile in place then work in "steps" following the lines

- drawn.
- Stick them down carefully.

• Balance cuts around the outside so they are greater than or equal to half a tile.

2.5 - Rolling out

- This must be done in two stages:
- Manually, using a cork smoothing press
- Rolling out over the entire surface with a 50 Kg roller during the laying process, then when installation is complete.

A perfect bonding is important to ensure a good conductibility.

2.6 - Treatment of joints

Seams must be hot welded

See "FINISHING chapter - treatment of joints". Heat welding flooring tiles.

2.7 - Sealing

As on the drawn or coving system See "FINISHING chapter".

2.8 - Putting into service trafficking

• For normal foot traffic, flooring can be used 48 hours at least after completion of work.

- For installing furniture and wheeled loads, wait 72 hours after completing work
- Do not use rubber feet.
- · Heated floors MUST be switched on 7 days after the flooring is laid





3 mm